



AGTechnologies

SPECIFICATION AGM 1602W-210_3.3V

Atualizado pelo MKT em 27/11/2015

	AGTech	nologie	MODLE NO : AGM 1602W-210_3.3V
REC	ORDS OF REV	VISION	DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SIIMMARY
0	2006/11/22		First issue
А	2008/09/24		Modify Character
			Generator ROM Pattern
В	2012/07/05		Correct ST7066IC
			information.
			Modify backlight
			information.
С	2014/07/22		Remove IC information
			Correct VDD-Vo.

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1.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) AGT have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) AGT have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, AGT have the right to modify the version.)

2.General Specification

Item	Dimension	Unit
Number of Characters	16 characters x 2Lines	—
Module dimension	84.0 x 44.0 x 13.2 (MAX)	mm
View area	66.0 x 16.0	mm
Active area	56.2 x 11.5	mm
Dot size	0.55 x 0.65	mm
Dot pitch	0.60 x 0.70	mm
Character size	2.95 x 5.55	mm
Character pitch	3.55 x 5.95	mm
LCD type	STN Positive, Yellow Green Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same ba	
Duty	1/16	
View direction	6 o'clock	
Backlight Type	LED, Yellow Green	
IC	ST7066U	

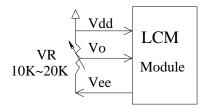
3.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T _{OP}	-20	_	+70	°C
Storage Temperature	T _{ST}	-30		+80	°C
Input Voltage	VI	V _{SS}		V _{DD}	V
Supply Voltage For Logic	VDD-V _{SS}	-0.3		7	V
Supply Voltage For LCD	V _{DD} -V _o	-0.3	_	13	V

4.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	3.0	3.3	3.6	V
Supply Voltage For LCD		Ta=-20°C	_		5.2	V
*Note	V_{DD} - V_0	Ta=25°C	3.6	3.7	3.8	V
		Ta=70°C	3.2	_	_	V
Input High Volt.	V _{IH}		$0.7 V_{DD}$		V _{DD}	V
Input Low Volt.	V _{IL}	_	Vss		0.6	V
Output High Volt.	V _{OH}	_	$0.7 V_{DD}$		V _{DD}	V
Output Low Volt.	V _{OL}	_	0		$0.2V_{DD}$	V
Supply Current	I _{DD}	V _{DD} =3.3V	1.0	1.2	1.5	mA

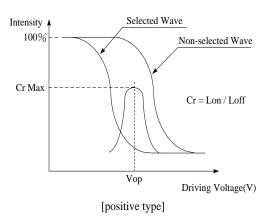
* Note: Please design the VOP adjustment circuit on customer's main board



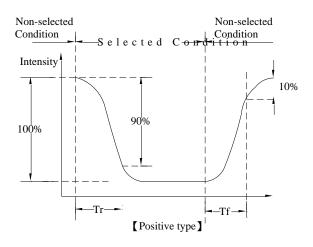
5.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	$CR \ge 2$	0	_	20	$\Psi = 180^{\circ}$
¥7: A1-	θ	$CR \ge 2$	0		40	$\psi=0^{\circ}$
View Angle	θ	$CR \ge 2$	0	—	30	$\Psi = 90^{\circ}$
	θ	$CR \ge 2$	0	_	30	$\psi=270^\circ$
Contrast Ratio	CR	_	_	3		_
Despense Time	T rise	—	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

Definition of Operation Voltage (Vop)



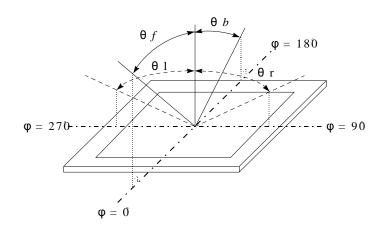
Definition of Response Time (Tr , Tf)



Conditions :

Operating Voltage : Vop Frame Frequency : 64 HZ Viewing Angle($\theta \rightarrow \phi$): $0^{\circ} \rightarrow 0^{\circ}$ Driving Waveform: 1/N duty, 1/a bias

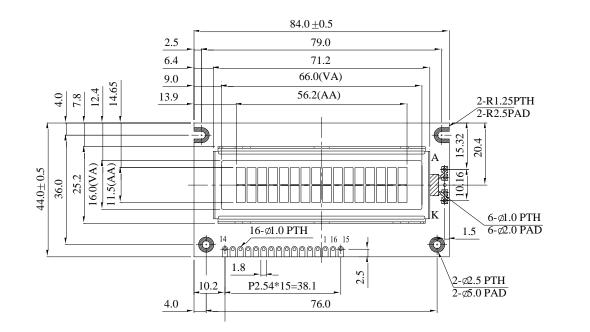
Definition of viewing angle($CR \ge 2$)

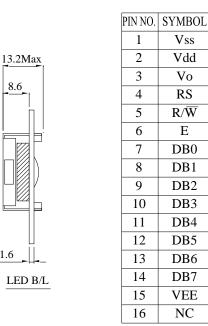


6.Interface Pin Function

Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	V_{DD}	3.3V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU \rightarrow Module) L: Write(MPU \rightarrow Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	VEE		Negative voltage output
16	NC		No connection

7.Contour Drawing & Block Diagram





8.6

1.6

Vss

Vdd

Vo

RS

R/W

Е

DB0

DB1

DB2 DB3

DB4

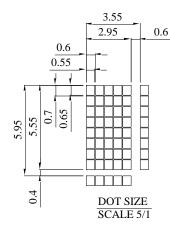
DB5

DB6

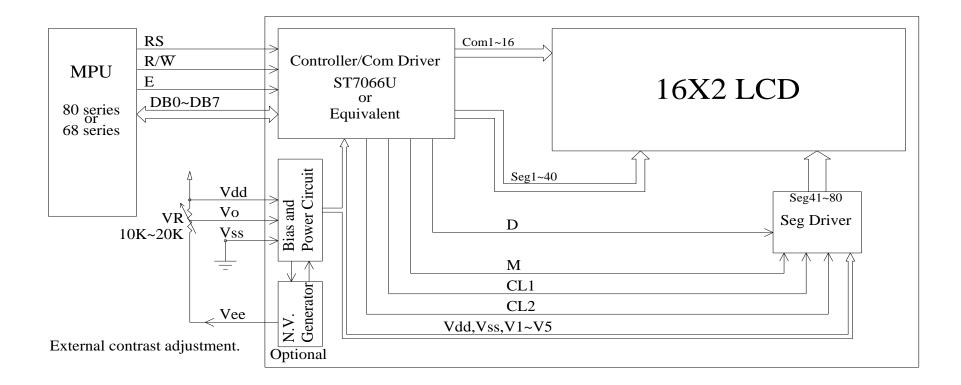
DB7

VEE

NC



The non-specified tolerance of dimension is ± 0.3 mm.



Character located	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DDRAM address	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
DDRAM address	40	41	42	43	44	45	46	47	48	49	4A	4 B	4C	4D	4E	4F

8.Character Generator ROM Pattern

Table.2

Upper 4 bit Lower	LLLL	LLLH	LLHL	LLHH	LHLL		LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
4 bit	CG RAM (1)					55 55 55 55 55 55 55 55 55 55 55 55 55	**************************************	5555 5555 5555 5555 5555 5555 5555 5555 5555				55555	5555 555 555 555 55	555 555 555		6666666 6 6 6 6 7 6 7 6 7 6 7 6 7 6 7 6
LLLH	(2)		2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	**************************************			5555 5555 55555 55555 5			555 55 55		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		55 555	
LLHL	(3)		19 19 19 19 19 19 19 19 19 19 19 19 19 1	555 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5			2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5			555 55 55	2 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8	1949 1949 1949 1949 1949 1949 1949 1949		64444 64 64 64 64 64 64 64 64 64 64 64 6	9999 9999 9999 9999 9999 9999 9999 9999 9999
LLHH	(4)		466666 666666 666666 66666 66666 66666	****** ** ***	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	- 	555 5 5 5555	8888			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	2 2 2 2 2 2 2 3 2 3 3 3 3 3 3 3 3 3 3 3	5	55555 55555 55 55 5555		10 0 0 10 10 0 0 0
LHLL	(5)			2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2			** **	55555 5 5 55555	៨៩៩៩៩ ៥	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	<i>ថិតិសិសិសិច</i> ខ្មី ខ្មាំដំពីទី	
LHLH	(6)			88888 8888 8888 8 888 888 888	555555 55 55555 55555 555555 5555555 5555		555 55555 5555	4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4			55 55	5555 5555 5555 555 555 555 555 555 55	5 5 5 5 5 5	555 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		
LHHL	(7)		1010 10					2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2			55555 55555 5	5 5	555			
LHHH	(8)		19 19 19					៨៩៩៩ ៩ ៩ ៩៩៩៩			5555 55 55 5 5		55555 55 55 5	5	888	
HLLL	(1)		d d d d'		444444 444444 444444 444444 444444						ដ ដីនីថិថី ខ្ល			2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	55 56 76 76 76 76 76 76 76 76 76 76 76 76 76	1999 1997 1997 1997 1997 1997 1997 1997
HLLH	(2)				ង មិថិថិថិ ទី	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	5 5 5 5 5 5 5 5 5 5 5 5 5			55555 55555 55555	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	6 6 6 6 6 6 6 6 6 6 6	4444 44444 44444	12 1	er e
HLHL	(3)		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55 55 55 55 55 55 55 55 55 55 55 55 55		55555 5 555555		55555 5 55555				55555 5 5 55555				55555 55555 55555
HLHH	(4)		5 5 5 5 5 5	20 20 20 20 20 20 20 20 20 20 20 20 20 2	៨៩៩៩៩ ៩ ៩ ៩ ៩	60 6 6	៨៩៩៩៩ ៥ ៥ ៥ ៥ ៥	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2				ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ ធ	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		55 55 75	
HHLL	(5)		1215 15		9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9	5 5 5 5 5 5 5 5 5	4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	바라바라 다			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55 55 55 55 55	55555 5 5 55	55555 55 5 5 5 5	99 99 99 99 99 99 99 99 99 99 99 99 99	66686 6 6 6 6 7 6 7 6 7 8 7 8 7 8 7 8 7
HHLH	(6)		****		៨៩៩៩៩៩៩ ៩៩៩ ៩៩៩ ៩៩៩៩៩៩	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				555 5 55555	55555 5 5 5 5 5 5 5	5 5 5	55 5 555	6 6 6 6 6 7 6 6 7 6 6 7 6 7 7 7 7 7 7 7	5 5555 5
HHHL	(7)		1010 1010		៨៨៩៩៩៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩ ៩	5 ⁵ 5	10 10 10 10 10 10 10 10 10 10 10 10 10 1	5 5 5 5 5			5555 5555 5555 5555		50 50 50 50 50 50 50 50 50 50 50 50 50 5	5 5	សសសម ខ្លាំ ខ្លាំ ខ្លាំ ខ្លាំ សសស	
нннн	(8)				2 2 2 2 2 3 2 3 3 3 3 3 3 3 3 3 3 3 3 3	5555	555 555 555 555	5 5 5 5 5			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5			555 55 555		chanchanar chanchanar chananar chananar chananar chananar

9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 $^{\circ}$ C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C in	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS= 800 V,RS= 1.5 k Ω CS= 100 pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

Specification

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION
Supply Current	ILED	117	130	156	mA	V=4.1V
Supply Voltage	V	3.9	4.1	4.3	V	-
Reverse Voltage	VR	_	_	8	V	-
Luminance (Without LCD)	IV	216	270	_	CD/M ²	ILED=130mA
Wave Length	λр	569	570	573	nm	ILED=130mA
Life Time	_	_	100000	_	Hr.	ILED≦130mA 25℃,50-60%RH
Color	Yellow Gre	en		<u>I</u>		1

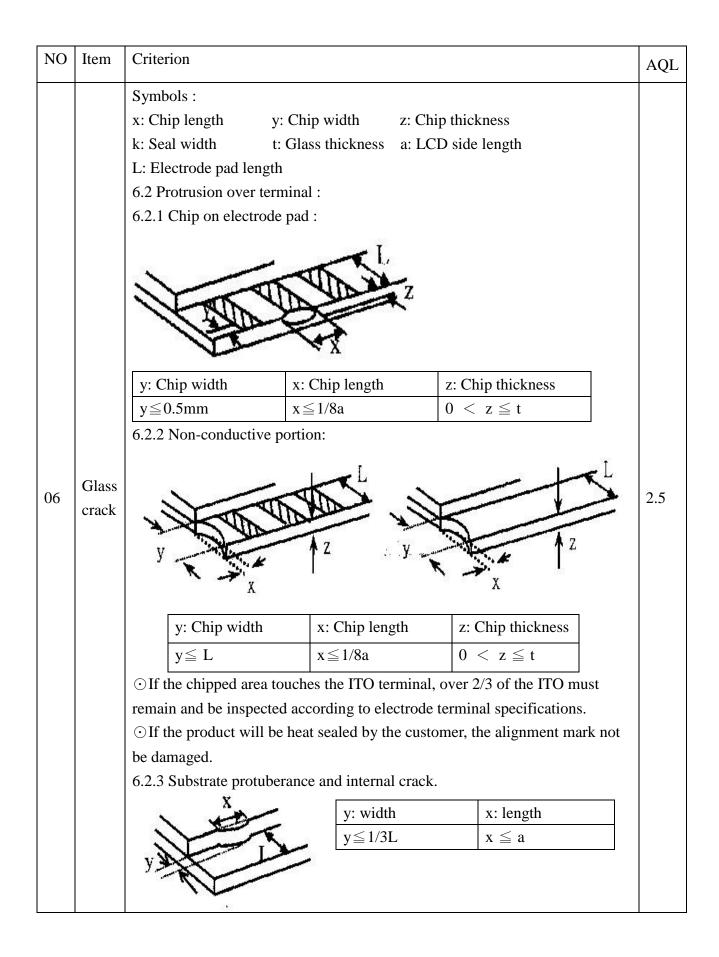
Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

LED B\L Drive Method 1.Drive from A , K R A B/L K

11.Inspection specification

NO	Item	Criterion				AQL				
		Missing vertica	l, horizont	tal segment, segmen	nt contrast defect.					
		Missing charact	ter , dot or	icon.						
		Display malfunction.								
01	Electrical	No function or no display.								
01	Testing	Current consumption exceeds product specifications.								
		LCD viewing a	ngle defec	et.						
		Mixed product types.								
		Contrast defect.								
	Black or	2.1 White and h	lack spots	s on display ≤ 0.25	mm, no more than					
02	white spots on	three white or b	-		linin, no more than	2.5				
02	LCD (display		-	-	or lines within 3mm	2.3				
	only)	2.2 Densery spe		nore than two spots	or miles wrunn shim					
		210 1	A C 11							
		3.1 Round type	: As follo							
		$\Phi = (x + y) / 2$	-	SIZE	Acceptable Q TY					
			1	$\Phi {\leq} 0.10$	Accept no dense	2.5				
			⊥ v	$0.10 < \Phi \le 0.20$	2					
	LCD black		Ţ ¹	$0.20 < \Phi \le 0.25$	1					
	spots, white			$0.25 \! < \! \Phi$	0					
03	spots,									
	contamination	3.2 Line type :	(As follow	ving drawing)	1					
	(non-display)	a 1 2	Length	Width	Acceptable Q TY					
		$\sim \sqrt{\frac{w}{1}}$		W≦0.02	Accept no dense					
			L≦3.0	$0.02 < W \le 0.03$	- 2	2.5				
			L≦2.5	$0.03 < W \le 0.05$	2					
				$0.05 \! < \! W$	As round type					
				C: A						
		If bubbles are v	,	Size Φ	Acceptable Q TY					
	Polarizer	judge using blac	-	$\Phi \leq 0.20$	Accept no dense					
04	bubbles	specifications, 1	•	$0.20 < \Phi \le 0.50$	3	2.5				
		to find, must ch		$0.50 < \Phi \le 1.00$	2					
		specify directio	n.	$1.00 < \Phi$	0					
				Total Q TY	3					

NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD bla	ack spots, white spots, c	ontamination	
	Scratches	Symbols Define: x: Chip length k: Seal width L: Electrode pad leng 6.1 General glass chip 6.1.1 Chip on panel su $\boxed{ z: Chip thickness} $ $\boxed{ z \leq 1/2t} $ $1/2t < z \leq 2t$	y: Chip width z: C t: Glass thickness a: L th:	Chip thickness CD side length n panels: x: Chip length $x \leq 1/8a$ $x \leq 1/8a$	2.5
		$z: Chip thickness$ $Z \leq 1/2t$	y: Chip width Not over viewing area	x: Chip length $x \le 1/8a$	
		$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	
		\odot If there are 2 or mo	re chips, x is the total le	ngth of each chip.	



NO	Item	Criterion				
07	Cracked glass	The LCD with extensive crack is not acceptable.				
08	Backlight	8.1 Illumination source flickers when lit.				
		8.2 Spots or scratched that appear when lit must be judged.				
	elements	Using LCD spot, lines and contamination standards.				
		8.3 Backlight doesn't light or color wrong.	0.65			
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints,				
		stains or other contamination.				
		9.2 Bezel must comply with job specifications.	0.65			
	PCB · COB	10.1 COB seal may not have pinholes larger than 0.2mm or				
		contamination.				
		10.2 COB seal surface may not have pinholes through to the IC.	2.5			
		10.3 The height of the COB should not exceed the height	0.65			
		indicated in the assembly diagram.				
		10.4 There may not be more than 2mm of sealant outside the	2.5			
		seal area on the PCB. And there should be no more than three				
		places.				
		10.5 No oxidation or contamination PCB terminals.	2.5			
10		10.6 Parts on PCB must be the same as on the production	0.65			
10		characteristic chart. There should be no wrong parts, missing				
		parts or excess parts.				
		10.7 The jumper on the PCB should conform to the product	0.65			
		characteristic chart.				
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5			
		screw hold pad, make sure it is smoothed down.				
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5			
		X				
		\mathbf{Y} X * Y<=2mm2				
11	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5			
		11.2 No cold solder joints, missing solder connections,	2.5			
		oxidation or icicle.				
		11.3 No residue or solder balls on PCB.	2.5			
		11.4 No short circuits in components on PCB.	0.65			

NO	Item	Criterion	AQL
	General appearance	12.1 No oxidation, contamination, curves or, bends on interface	
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
		12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

<u>12.Material List of Components for</u> <u>RoHs</u>

 AGTECHNOLOGIES hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs			
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm			
Above limited value is set up according to RoHS.									

2.Process for RoHS requirement :

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow : 250° C, 30 seconds Max. ;

Connector soldering wave or hand soldering $: 320^{\circ}$ C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : $235\pm5^{\circ}C$;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

13.Recommendable Storage

- 1. Place the panel or module in the temperature $25^{\circ}C\pm 5^{\circ}C$ and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.